SN54ACT564 ... J OR W PACKAGE

SN74ACT564 ... DB, DW, N, OR PW PACKAGE

(TOP VIEW)

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- Inputs Are TTL-Voltage Compatible
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-µm Process
- 3-State Inverted Outputs Drive Bus Lines Directly
- Flow-Through Architecture to Optimize **PCB** Layout
- Full Parallel Access for Loading
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIPs

### description

The 'ACT564 are octal D-type edge-triggered flip-flops that feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

On the positive transition of the clock (CLK) input, the  $\overline{Q}$  outputs are set to the complements of the logic levels set up at the data (D) inputs.

A buffered output-enable (OE) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54ACT564 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ACT564 is characterized for operation from -40°C to 85°C.

(each flip-flop)								
	INPUTS	OUTPUT						
OE	CLK	D	Q					
L	$\uparrow$	Н	L					
L	$\uparrow$	L	н					
L	H or L	Х	Q <sub>0</sub> Z					
н	Х	Х	Z					

FUNCTION TABLE



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_	•		1.04	
]	7	15	5 <mark>Q</mark>	

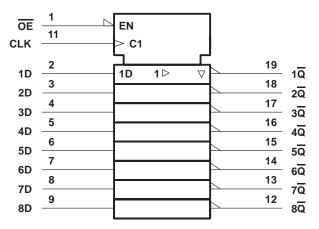
OE [ 1D [ 2D [ 3D [ 4D [ 5D [ 6D [ 7D [	3 4 5 6 7 8	υ	20 19 18 17 16 15 14 13	
_			13 12 11	] 7Q ] 8Q ] CLK

SN54ACT564 ... FK PACKAGE (TOP VIEW)

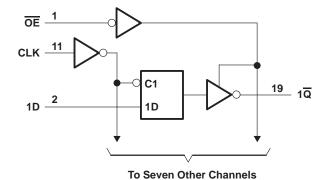
	2 <del>2</del> 1	n S≥n⊄	
3D ] 4D ] 5D ] 6D ] 7D ]	6 7 8 9 10 1	18 17 16 15 12 1 12 13	
	GND GND	80 80 70	

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### logic symbol<sup>†</sup>



logic diagram (positive logic)



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Note 1)	$-0.5 \text{ V}$ to $\text{V}_{\text{CC}}$ + 0.5 V
Input clamp current, $I_{IK}$ (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> )	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V <sub>CC</sub> or GND	±200 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2):	DB package 0.6 W
	DW package 1.6 W
	N package 1.3 W
	PW package 0.7 W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.



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### recommended operating conditions (see Note 3)

		SN54ACT564		T564 SN74ACT564		LINUT
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	2	2		V
VIL	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	Vcc	0	VCC	V
Vo	Output voltage	0,	Vcc	0	VCC	V
ЮН	High-level output current	D D	-24		-24	mA
IOL	Low-level output current	202	24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Q 0	8	0	8	ns/V
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vee	T <sub>A</sub> = 25°C			SN54ACT564		SN74ACT564		UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	1	4.5 V	4.4	4.49		4.4		4.4		
	I <sub>OH</sub> = -50 μA	5.5 V	5.4	5.49		5.4		5.4		
Vou	10.1 24 mA	4.5 V	3.86			3.7		3.76		V
VOH	I <sub>OH</sub> = -24 mA	5.5 V	4.86			4.7		4.76		v
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	I <sub>OH</sub> = -75 mA <sup>†</sup>	5.5 V					N.	3.85		
	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1		0.1	v
		5.5 V			0.1		0.1		0.1	
No.	I <sub>OL</sub> = 24 mA	4.5 V			0.36	t.	0.5		0.44	
VOL		5.5 V			0.36	) N	0.5		0.44	
	I <sub>OL</sub> = 50 mA <sup>†</sup>	5.5 V				20	1.65			
	I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V				Q			1.65	
I <sub>OZ</sub>	$V_{O} = V_{CC}$ or GND	5.5 V			±0.25		±5		±2.5	μA
Ц	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±0.1		±1		±1	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			4		80		40	μΑ
∆ICC‡	One input at 3.4 V, Other inputs at GND or V <sub>CC</sub>	5.5 V		0.6			1.6		1.5	mA
Ci	$V_I = V_{CC} \text{ or } GND$	5 V		4.5						pF
Co	$V_{O} = V_{CC}$ or GND	5 V		15						pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

		T <sub>A</sub> = 2	25°C	SN54ACT564	SN74A	CT564	UNIT
		MIN	MAX	MIN MAX	MIN	MAX	UNIT
tw	Pulse duration, CLK high or low	3		171 121	3.5		ns
t <sub>su</sub>	Setup time, data before CLK1	2.5		3.5	3		ns
t <sub>h</sub>	Hold time, data after CLK1	1		2.5	1		ns

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

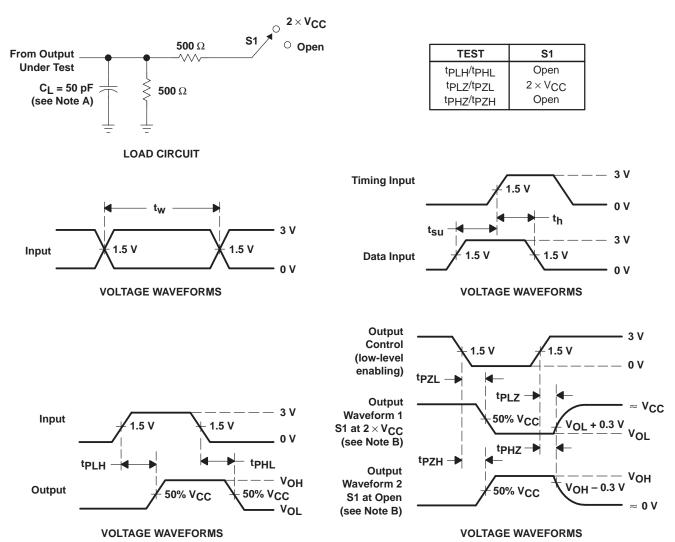
PARAMETER	FROM	то	Т	λ = 25°C	;	SN54A	CT564	SN74A	CT564	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
f <sub>max</sub>			85	90		65	M.	75		MHz	
<sup>t</sup> PLH	CLK	Q	2	6.5	10.5	1	12.5	1.5	11.5	ns	
<sup>t</sup> PHL	CLK	Q Q	1.5	6	9.5	1	11.5	1.5	10.5	115	
<sup>t</sup> PZH	OE	Ы	1.5	5.5	9	14	10.5	1.5	9.5	200	
<sup>t</sup> PZL	UE UE	ā	Q	1.5	5.5	8.5	96(	10.5	1	9.5	ns
<sup>t</sup> PHZ	ŌĒ	D	1.5	7	10.5	01	12.5	1.5	11.5	20	
<sup>t</sup> PLZ	UE	Ŷ	1.5	5	8	<b>Q</b> 1	9.5	1	8.5	ns	

# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS	ТҮР	UNIT
C <sub>pd</sub> Pc	ower dissipation capacitance	C <sub>L</sub> = 50 pF, f = 1 MHz	50	pF



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### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

- Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.

D. The outputs are measured one at a time with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



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